

**DECLARATION AND POWER OF ATTORNEY FOR PATENT APPLICATION**DOCKET NO. IME03-002

As a below-named Inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name;

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled  
**Shallow Multi-Well Plastic Chip For Thermal Multiplexing**

the specification of which (check one)

 is attached hereto.

was filed on \_\_\_\_\_

Application Serial No. \_\_\_\_\_

and was amended on \_\_\_\_\_ (if applicable)

I hereby state that I have reviewed and understand the contents of the above Identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose information which is material to the examination of this application in accordance with Title 37, Code of Federal Regulations, §1.56(a).

I hereby claim foreign priority benefits under Title 35, United States Code, §119 of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:

Prior Foreign Application(s)

Priority Claimed:

(Number)	(Country)	(Day/Month/Year Filed)
(Number)	(Country)	(Day/Month/Year Filed)
<u>60/456,929</u>	<u>3/24/03</u>	<u>Pending</u>
(Application Serial No.)	(Filing Date)	(Status) (patented, pending, abandoned)

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

**POWER OF ATTORNEY:** As a named inventor, I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and transact all business in the Patent and Trademark Office connected therewith. (list name & registration no.)

**GEORGE O. SAILE** (Reg. No. 19,572), **STEPHEN B. ACKERMAN** (Reg. No. 37,761)

Send Correspondence to: 28 DAVIS AVENUE, POUGHKEEPSIE, NEW YORK 12603

Direct telephone Calls to: (name & telephone number) **GEORGE O. SAILE** NEW YORK 845 452-5863**YUBO MIAO**

Full name of sole or first inventor

Date

16/6/2003

Inventor's signature

BLK 227, Choa Chu Kang Central, #08-183, Singapore 680227 Singapore

Residence

**Singapore**

Citizenship

10 Science Park Road, #01-01/03 The Alpha, Singapore Science Park II, Singapore 117684  
Post Office Address:

**YU CHEN**

DOCKET NO. INTEL-002

Full name of second inventor

Investor's signature

M.K. 134-516-01, Upper Biulid Complex Road, Singapore S8127 Singapore  
Residence

People's Republic of China  
Citizenship

10 Science Park Road, #01-01/03, The Alpha, Singapore Science Park II, Singapore 117684  
Post Office Address

**TIT MONG LIM**

Full name of third inventor

1/7/03 Date

July 1, 2003

Investor's signature

7 Toh Tuck Plaza, Singapore 596743 Singapore  
Residence

Singapore  
Citizenship

10 Science Park Road, #01-01/03, The Alpha, Singapore Science Park II, Singapore 117684  
Post Office Address

**CHEW KIAT HENG**  
Full name of fourth inventor

Henry W. Ong  
Investor's signature

1/7/03 Date

July 1, 2003

BLR 130, Ang Mo Kio Ave. 3, #25-2594, Singapore S56130 Singapore  
Residence

Singapore  
Citizenship

10 Science Park Road, #01-01/03, The Alpha, Singapore Science Park II, Singapore 117684  
Post Office Address

Full name of fifth inventor

Date

Investor's signature

Residence

Citizenship

Post Office Address

Full name of sixth inventor

Date

Investor's signature

Residence

Citizenship

Post Office Address